

# HCL head says step in sync with self-reliant India vision

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**LUCKNOW:** HCL Technologies and Hon Hai Technology Group (Foxconn) have got Union Cabinet's approval to set up an OSAT facility (outsourced semiconductor assembly and test) in Yamuna Expressway Industrial Development Authority (YEIDA) region near Jewar airport in Uttar Pradesh. This decision to approve the ₹3,706 crore OSAT facility marks a significant milestone under India Semiconductor Mission.

Roshni Nadar Malhotra, chairperson, HCL Technologies, on Thursday said, "We are grateful to the Honourable Prime Minister and the Government of India for their support in approving the semiconductor OSAT unit in Jewar, through our joint venture with Foxconn. Our partnership combines HCL's deep-rooted engineering DNA and depth in technology

with Foxconn's semiconductor capabilities."

"This collaboration will support key sectors such as consumer electronics, automotive, and industrial systems. The facility, with a capacity of 20,000 wafers per month, will help meet the growing demand for advanced technologies. It is expected to generate over 3,500 jobs," she added.

"We are also focused on building semiconductor skills and enabling India's workforce in this field. This initiative is aligned with the vision of Atmanirbhar Bharat and we are happy to support it," she added.

The upcoming plant will manufacture display driver chips used in mobile phones, laptops, automobiles, PCs and other devices with displays. The new semiconductor unit—the first in Uttar Pradesh—is expected to contribute significantly to meeting domestic demand for such chips.